

In re Application of:

Kovarsky, et al.

Serial No.: 10/690,408

Confirmation No.: 7371

Filed: October 21, 2003

For: Copper Replenishment for  
Copper Plating With  
Insoluble Anode

Group Art Unit: 1742

Examiner: Harry D. Wilkins, III

MAIL STOP AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited on with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, or electronically transmitted to the U.S. Patent and Trademark Office via EFS-Web to the attention of Examiner Harry D. Wilkins, III, on the date shown below.

September 11, 2006  
Date

Steven H VerSteege

Dear Sir:

**RESPONSE TO FINAL OFFICE ACTION DATED JULY 12, 2006**

In response to the Final Office Action dated July 12, 2006, having a shortened statutory period for response set to expire on October 12, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/008541/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 4 of this paper.